

Features

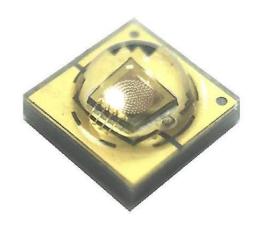
- 3535 IR VCSEL
- ROHS and REACH Compliant
- ESD(HBM) 4KV
- MSL 4 Qualified (J-STD 020)

Applications

- Industrial facility applications
- Consumer Mobile
- Automotive Interior & Exterior
- 3D Sensing(TOF, Structure Light)
- Bio recognition

Description

The INV-C33CTOHIR is a high-power IR VCSEL. It is a SMD type package which can be used in various applications.



Recommended Solder Pattern

(Suggest Stencil t=0.12 mm)

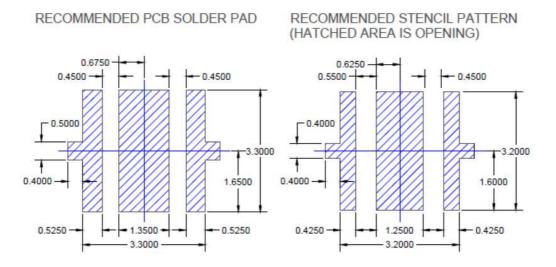


Figure 1. INV-C33CTOHIR Recommended Solder Pattern

Note:

- *All dimensions are in millimeters.
- *Tolerance is ±0.05mm unless other specified.



Package Dimensions in mm

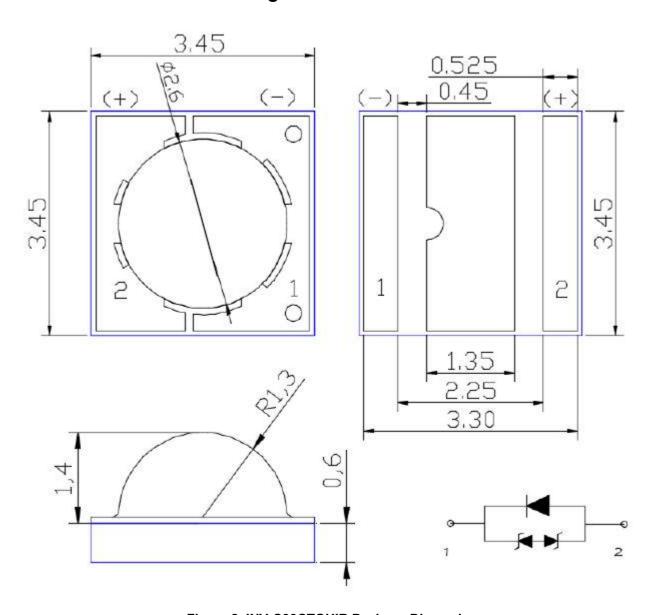


Figure 2. INV-C33CTOHIR Package Dimensions

*Note

All dimensions are in millimeters. Tolerance is ± 0.05 mm unless other specified.



Absolute Maximum Rating at 25°C (Note 1)

Product	I _{FP} (mA) max Pulse Current (@1/10 duty)	DC Forward Current (mA)		V _R (V) Typ	T _j (°C) Typ.	T _{ST} (°C)	Rth (°C/W)	Soldering Temp. T _{sol} (°C)
		Тур	Max					
INV-C33CTOHIR	1500	1000	1200	-5	110°C	-40°C~+100°C	10	260°C

Notes

- 1. For other ambient, limited setting of current will depend on de-rating curves.
- 2. D=0.01s duty 1/10.
- 3. When drive on maximum current , Tj must be kept below 110° C
- 4. Viewing angle(2 θ 1/2) \pm 10°

Electrical Characteristics $T_A = 25^{\circ}$ (Note 1)

Product	V _F (V)@1200mA		Radiometric Power (mW) @1200mA		Peak Wavelength (nm)		l _R (μ A)	View Angle
1100000	min	max	min	max	min	max	max	2 $ heta$ 1/2
INV-C33CTOHIR	1.8	2.8	700	1100	930	950	5	30

*Notes

- 1. Performance guaranteed only under conditions listed in above tables.
- 2. Viewing angle $(2\theta 1/2) \pm 10^{\circ}$

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Binning Definition (Binning@1200mA)

Power Bin

Bin Code	Min.	Max.	Unit
P70	700	800	
P80	800	900	ma\A/
P90	900	1000	mW
P100	1000	1100	

Wavelength Bin

Bin Code	Min.	Max.	Unit
W94	930	950	nm

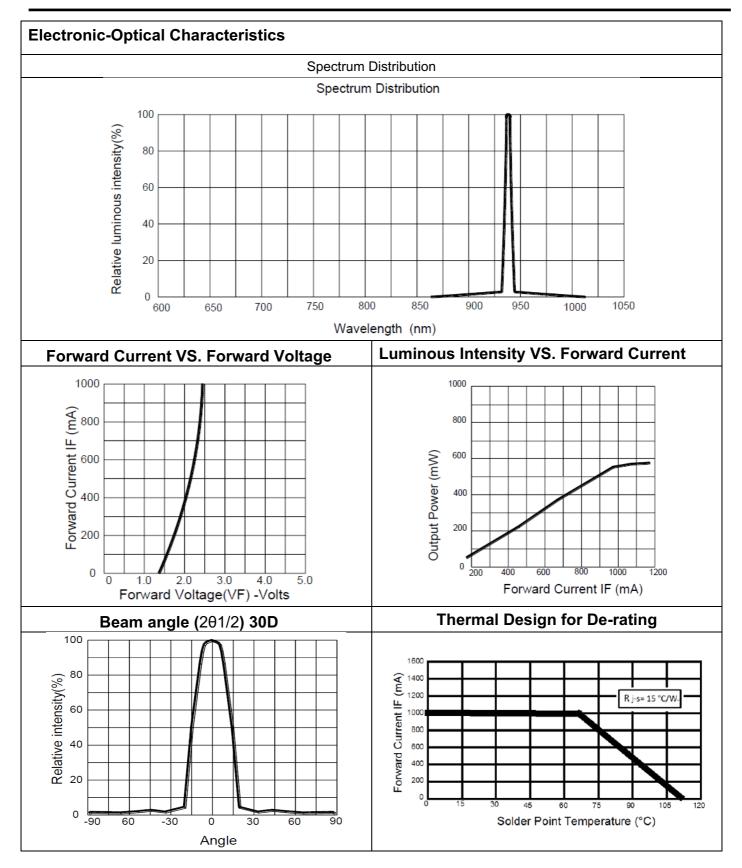
Voltage Bin

Bin Code	Min.	Max.	Unit
V1	1.8	2.2	
V2	2.2	2.6	V
V3	2.6	2.8	

*Notes:

- 1. Radiometric Power (Po) ±10%.
- 2. Wavelength (Wp) ±2.0nm
- 3. Forward voltage (V_F) ±0.12V





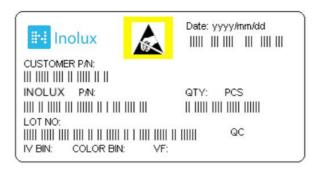
*Notes: Viewing angle (2θ1/2) ± 10°



Ordering Information

Orderable	Peak	@120011A		Forward \ @120	Viewing	
Part Number	Wavelength (nm)	Min	Max	Min	Max	Angle
INV-C33CTOHIR	930-950	700	1100	1.8	2.8	30°

Label Specifications



Inolux P/N:

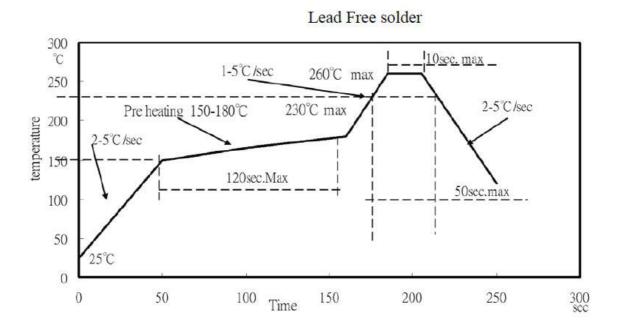
INV	-	С	3	3	С	Т	0		HIR	-	Х	Х	X Z	Х
		Material	Pacl	kage	Variation	Orientation	Current	Lens	Color			ıstom tamp		
Inolux VCSEL		C = Ceramic Type	33C =	- 3.5 x 3	3.5, 120 Deg.	T = Top Mount	O = 1200mA	(Blank) = Clear	HIR = 940nm					

Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2010 \	Month	Data	Corial	
Tracker		Year (2017	, 2018,)	Month	Date	Serial	



Reflow Soldering



Soldering Iron

Basic Spec is \leq 4 sec. when 260°C (+10°C \rightarrow -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

Rework

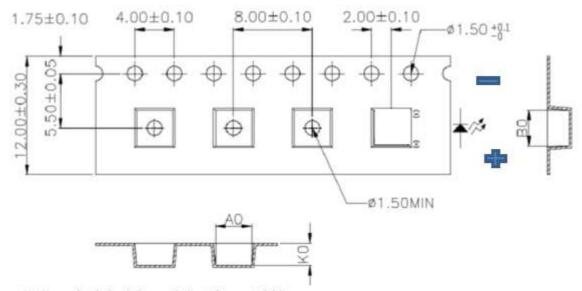
Rework should be completed within 4 second under 245°C

Notes

- 1. Do not stress the silicone resin while it is exposed to high temperature.
- 2. The number of reflow process should not exceed 3 times.

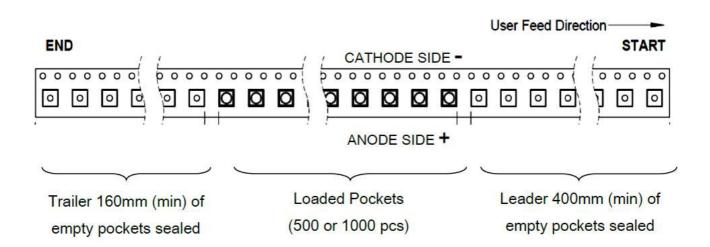


Packing

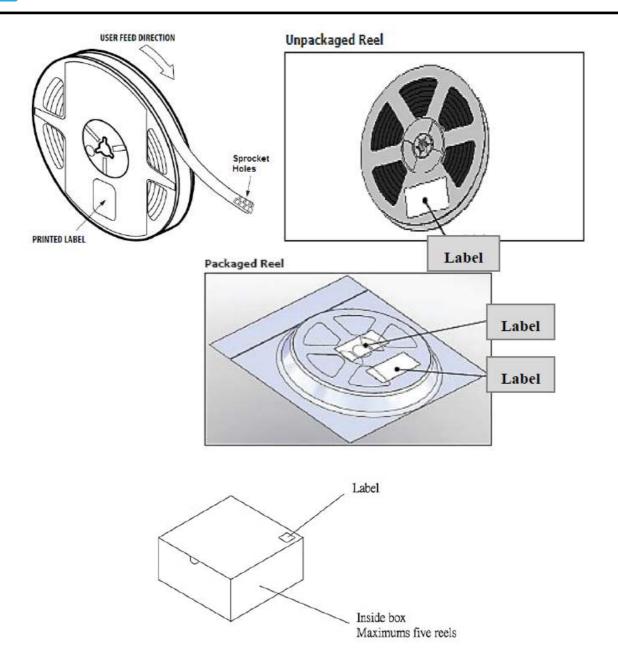


- 10 sprocket hole pitch cumulative tolerance ±0.20.
- Carrier camber is within 1 mm in 250 mm.
 Material : Black Conductive Polystyrene Alloy.
- All dimensions meet EIA-481-D requirements.
- 5. Thickness: 0.30±0.05mm.

т	0.30 <u>±</u> 0.05			
A0	3.80±0.1			
B0	3.80±0.1			
K0 (60D LENS)	2.90 <u>+</u> 0.1			
K0 (120D LENS)	2.20 <u>+</u> 0.1			







Notes:

- 1. Each Reel (minimum number of pieces is 100 and maximum is 500 (60D)/1000 (120D) is packed in a moisture-proof bag along with 2 packs of desiccant and a humidity indicator card;
- 2. A maximum of 5 moisture-proof bags are packed in an inner box (size: 240mm x 200mm x 105mm ±5mm)
- 3. A maximum of 4 inner boxes are put in an outer box (size: 410mm x 255mm x 230mm ±5mm)
- 4. Part No., Lot No., quantity should be indicated on the label of the moisture-proof bag and the cardboard box.



Revision History

Changes since last revision	i	Page	Version No.	Revision Date
Initial Release			1.0	02-03-2019
Update the Drawing and Parameter		3, 4	1.1	05-14-2019

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